

Product / Process Change Notification



N° 2015-065-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of leadframe material with pre-plating process at Infineon (Malacca) and release of 2nd location (Malacca) for final plating process, affecting PDSOF packages

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **28. April 2016**.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

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at Infineon (Malacca) and release of 2nd location
(Malacca) for final plating process, affecting PDSOF
packages



Sales Name	SP number	OPN	Package
KP108-AD	SP000714416	KP108ADXTMA1	PG-DSOF-8-16
KP108-AD	SP000928686	KP108ADXTMA2	PG-DSOF-8-16
KP108-PS	SP000714420	KP108PSXTMA1	PG-DSOF-8-16
KP200	SP000628804	KP200XTMA1	PG-DSOF-8-16
KP200	SP000849342	KP200XTMA2	PG-DSOF-8-16
KP200	SP000926408	KP200XTMA3	PG-DSOF-8-16
KP214E2611	SP001052926	KP214E2611XTMA1	PG-DSOF-8-16
KP214N2611	SP000763326	KP214N2611XTMA1	PG-DSOF-8-16
KP215F1701	SP000698278	KP215F1701XTMA1	PG-DSOF-8-16
KP216H1416	SP000698282	KP216H1416XTMA1	PG-DSOF-8-16
KP216K1409	SP000698288	KP216K1409XTMA1	PG-DSOF-8-16
KP219M1203	SP001092802	KP219M1203XTMA1	PG-DSOF-8-16
KP219N1904	SP001092808	KP219N1904XTMA1	PG-DSOF-8-16
KP219N3621	SP000824058	KP219N3621XTMA1	PG-DSOF-8-16
KP224N3111	SP001040362	KP224N3111XTMA1	PG-DSOF-8-16
KP226K2809	SP000724842	KP226K2809XTMA1	PG-DSOF-8-16
KP226N3022	SP000946462	KP226N3022XTMA1	PG-DSOF-8-16
KP226N3622	SP000941570	KP226N3622XTMA1	PG-DSOF-8-16
KP229E2701	SP000699514	KP229E2701XTMA1	PG-DSOF-8-16
KP229E3111	SP001031312	KP229E3111XTMA1	PG-DSOF-8-16
KP229E3201	SP001163002	KP229E3201XTMA1	PG-DSOF-8-16
KP229E3518	SP000808692	KP229E3518XTMA1	PG-DSOF-8-16
KP229-IG E3518	SP001016422	KP229IGE3518XTMA1	PG-DSOF-8-19
KP229K0115	SP001372044	KP229K0115XTMA1	PG-DSOF-8-16
KP229L2920	SP000788810	KP229L2920XTMA1	PG-DSOF-8-16
KP234	SP000700772	KP234XTMA1	PG-DSOF-8-16
KP235	SP000700776	KP235XTMA1	PG-DSOF-8-16
KP235C4115	SP000998886	KP235C4115XTMA1	PG-DSOF-8-16
KP236	SP000700780	KP236XTMA1	PG-DSOF-8-16
KP236N6165	SP000700784	KP236N6165XTMA1	PG-DSOF-8-16
KP236N6165	SP000862150	KP236N6165XTMA2	PG-DSOF-8-16
KP253	SP000843708	KP253XTMA1	PG-DSOF-8-16
KP253HP	SP001045834	KP253HPXTMA1	PG-DSOF-8-16
KP254	SP000773948	KP254XTMA1	PG-DSOF-8-16
KP256	SP000773952	KP256XTMA1	PG-DSOF-8-16

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SUBJECT OF CHANGE: Introduction of leadframe with pre-plating process at Infineon (Malacca) and release of 2nd location (Malacca) for final plating process, affecting PDSOF packages.

PRODUCTS AFFECTED: Please refer to 1_cip15065_a.

REASON OF CHANGE:

- Introduction of new leadframe supplier to ensure secure supply.
- Extension of capacity

DESCRIPTION OF CHANGE:	OLD	NEW
■ Pre-plating location:	Leadframe supplier	Infineon Malacca, Malaysia
■ Final plating location:	Infineon Regensburg, Germany	Infineon Regensburg, Germany and Infineon Malacca, Malaysia

PRODUCT IDENTIFICATION: Traceability is ensured by lot number and date code.

TIME SCHEDULE:

■ Final qualification plan:	Available on demand
■ Final qualification report:	15 June 2016
■ First samples available:	Available on request
■ Intended start of delivery:	15 January 2017

ASSESSMENT: No change in fit, form or function expected.
No impact on reliability and processability.

Documentation: 1_cip15065_a: affected product list